

. 8th March, 1993.

To : IEEE 802 Executive Committee and IEEE 802.9

From : Richard Brand, National Semiconductor Corp.

Subject : Licensing of Patents

The newly proposed PAR (3/93) for a new 16.384 Mbps. Physical Layer addition to the IEEE 802.9 standard may include some Intellectual Property now covered by patents granted , or to be granted to National Semiconductor Corporation. If the forthcoming proposal should become approved by the IEEE Standards boards, National Semiconductor will grant a license on a non-discriminatory basis for a reasonable fee, to any requestor of such license.